

Epoxy Resin Systems Plastic Metal

WEICON WAL06

Pasty mineral-filled impact-resistant adheres to wet and moist surfaces

WEICON WAL06 is a 2-component epoxy resin with high adhesive strength, enormous impact resistance as well as high residual elasticity and abrasion resistance. Due to its high elongation at break and paste-like texture, WEICON WAL06 can be used for repairs, as abrasion protection as well as for lining heavily stressed equipment. The adhesive also shows excellent adhesion to wet and damp surfaces and in underwater applications.

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Characteristics		
Base		Ероху
Filler		mineral
Texture		pasty
Colour		white
Processing		
Processing temperature		+15°C to +40°C
Relative air humidity		< 85 %
Mixing ratio by weight		100:83
Mixing ratio by volume		100:95
Viscosity of the mixture	at +25 °C	550.000 mPa⋅s
Density of the mixture		1,5 g/cm ³
Consumption	Layer thickness 1.0 mm	1.5 kg/m ²
Max. layer thickness	per step	10 mm
Curing		
Pot life	at 20 °C, 500 g batch	30 min.
Additional layer after	(35 % strength)	7 h
Working strength after	(80 % strength)	12 h
Final strength	(100 % strength)	36 h
Shrinkage		0,12 %
Mechanical properties after of	curing	
- Measured after curing at		24 h RT + 4 h +60 °C
Tensile strength	DIN EN ISO 527-2	21 MPa
Elongation at break (tensile)	DIN EN ISO 527-2	9.0 %
E-modulus (tensile)	DIN EN ISO 527-2	1300-1500 MPa
Compressive strength	DIN EN ISO 604	65 MPa
Bending strength	DIN EN ISO 178	50 MPa
Impact strength	DIN EN ISO 179-1/1eU	21 kJ/m²
Hardness (Shore D)	DIN ISO 7619	75±3
Taber Test	DIN ISO 9352 (H18, 1 kg, 1000 rotations)	0,5 g / 0,3 cm ³
Lap shear strength material thic	ckn. 1,5mm DIN EN 1465	
Steel 1.0338 sandblas	sted	21 MPa
Stainless steel V2A sa	ndblasted	24 MPa
Aluminium sandblaste	ed	14 N/mm²
Galvanized steel		8 MPa

Thermal parameters

-		
Temperature resistance		-35°C to +160°C
Tg after curing at room temperature	(DSC)	~ +64 °C
Tg after tempering (at 120°C)	(DSC)	+87 °C
Heat deflection resistance	DIN EN ISO 75-2	+65 °C
Thermal conductivity	DIN EN ISO 22007-4	0,4 W/m⋅K
Heat capacity	DIN EN ISO 22007-4	1,1 J/(g·K)
Electrical parameters		
Resistance	DIN EN 62631-3-1	5,8·10 ¹¹ Ω·m
Magnetic		no

Instructions for use

When using WEICON products, the physical, safety-related, toxicological and ecological data and regulations in our EC safety data sheets (www.weicon.com) must be observed.

Surface pre-treatment

The successful application of WEICON WAL06 depends on the thorough pre-treatment of all surfaces. This is the most important factor for overall success. Dust, dirt, oil, grease, rust and moisture or wetness have a negative impact on the adhesion. Therefore, before processing WEICON WAL06, the following points must be observed: The areas to be bonded or repaired must be free of any oil, grease, dirt, rust, oxides, paint and other impurities or residues. For cleaning and degreasing, we recommend WEICON Cleaner Spray S.

Smooth and particularly heavily soiled surfaces should additionally be treated by mechanical surface pre-treatment, e.g. by grinding or preferably by blasting. In case of blasting, the surface should be brought to a degree of purity of SA 2 ½ - "Near White Blast Cleaning" (according to ISO 8501/1-2, NACE, SSPC, SIS). In order to achieve an optimum surface roughness of 75 - 100 µm, angular, disposable blasting media (aluminum oxide, corundum) should be used. The surface quality is negatively influenced by the use of reusable blasting media (slag, glass, quartz), but also by ice blasting. The air for blasting must be dry and oil-free. Metal parts that have come into contact with sea water or other salt solutions should first be rinsed thoroughly with demineralised water and, if possible, left to rest overnight so that all salts can be dissolved from the metal. Before each application of WEICON WAL06, a test for soluble salts should be carried out according to the Bresle method (DIN EN ISO 8502-6).

Mixing

First, stir the resin. Then mix the resin and hardener together thoroughly and bubble-free for at least four minutes at 20°C (68°F). The included processing spatula or a mechanical mixer, such as a mortar stirrer, can be used for this purpose. With mechanical mixers, a low speed of max. 500 rpm should be used. The components should be stirred until a homogeneous mixture is achieved. The mixing ratio of the two components must be strictly observed, as otherwise, strongly deviating physical values will result (max. deviation +/- 2 %). Only

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prepare a batch as large as can be processed within the pot life of 30 minutes. The specified pot life refers to a material batch of 500 g and 20°C (68°F) material temperature. Mixing larger quantities or higher processing temperatures will result in faster curing due to the typical reaction heat of epoxy resins.

Application

For processing, we recommend an ambient temperature of 20°C (68 °F) at less than 85% relative humidity. For a thin precoat, work WEICON WAL06 intensively into the surface in crosswise layers using the Contour Spatula Flexy to achieve maximum adhesion. By means of this technique, the epoxy resin penetrates well into all cracks and roughness depths. Afterwards, further applications can be carried out straight away, until the desired layer thickness is reached. Make sure that the epoxy resin is applied evenly and without air bubbles. To fill large gaps or holes, fibreglass, expanded metal or other mechanical fixing materials should be used. Finally, the surface can be smoothed easily with the help of a PE film and a rubber roller.

Curing

Final hardness is reached after 24 hours at 20°C (68°F) at the latest. At lower temperatures, the curing can be accelerated by evenly applying heat up to max. 40°C (104°F), e.g. with a heating pack, hot air blower or fan heater. Higher temperatures shorten the curing time. The following rule of thumb applies: Each increase by +10°C (50°F) above room temperature (20°C/68°F) will decrease the curing time by half. Temperatures below 16°C (61°F) increase the curing time, until at approx. 5°C (41°F) and below, almost no reaction will take place at all.

Storage

Store WEICON WAL06 at room temperature in a dry place. Unopened containers can be stored at temperatures of +18°C to +28°C for at least 36 months after delivery date. Opened containers must be used up within 6 months.

Scope of delivery

Processing Spatula | Contour Spatula Flexy | Instructions for use | Gloves | Resin & Hardener

Accessories

10000347 10000147 10024313 10025288 10026647 10026712 10053995 10000913 10022562 10010887 10016002 10039667	Cleaner S, 5 L, colourless, transparent Cleaner Spray S, 500 ml, transparent Surface Cleaner, 400 ml, transparent Surface Cleaner, 5 L, transparent Mould Release Agent Liquid F 1000, 250 ml, white, milky Mould Release Agent Wax P 500, 150 g Repair Stick Multi-Purpose, 115 g, vintage white Glass Fibre Cloth Tape, 1 PCE, white Processing Spatula Processing Spatula, 1 PCE Pump Dispenser WPS 1500, 1 PCE Cable Scissors No. 35, 1 PCE
10039667 10045523	

Recommended equipment

Heat pocket	PE film 0.2 mm
Hot or fan heater	Brush
Smoothing trowel, spatula	Foam roller
Fabric tape	

Conversion table

$(^{\circ}C \times 1.8) + 32 = ^{\circ}F$	Nm x 8.851 = lb·in
mm/25.4 = inch	$Nm \times 0.738 = lb \cdot ft$
μm/25.4 = mil	Nm x 141.62 = oz·in
$N \times 0.225 = Ib$	mPa⋅s = cP
$N/mm^2 x 145 = psi$	$N/cm \times 0.571 = Ib/in$
MPa x 145 = psi	$kV/mm \times 25.4 = V/mil$

Available sizes

10030626 WEICON WAL06, 2 kg, white

	WEICON A	WEICON B	WEICON BR	WEICON C	WEICON F	WEICON F2	WEICON HB 300	WEICON HT 111	WEICON SF	WEICON ST	WEICON TI	WEICON UW	WEICON WR2	WEICON HP	WEICON Fire Safe	WEICON Anti-Static	WEICON Food Grade	WEICON Anti-Stick	WEICON Ceramic BL	WEICON GL	WEICON GL-S	WEICON Ceramic W	WEICON Ceramic HC 220	WEICON WP	WEICON WR	WEICON CBC
Repair and moulding	х	х	х	x	х	x	x	х	x	х	х	х	х													
Adhesive				х	х		х	х		х				х	х											
Wear, erosion and corrosion protection – abrasion-resistant coating																x	х	х	х	х	х	х	x	x		
Casting, relining and gap compensation – casting and injecting potting compound	х					x							х												х	х





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info@weicon.es

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Chemical resistance of WEICON Plastic Metals after curing* (Excerpt)

Exhaust fumes	+	Potassium carbonate	+
Acetone	-	Potassium hydroxide 0-20 % (caustic potash)	+
Ethyl ether	0	Milk of lime	+
Ethyl alcohol	0	Carbolic acid	-
Ethylbenzene	-	Creosote oil	-
Alkalis (alkaline substances)	+	Cresylic acid	-
Hydrocarbons, aliphatic (petroleum derivatives)	+	Magnesium hydroxide	+
Formic acid >10 % (methanoic acid)	-	Maleic acid (cis-ethylenedicarboxylic acid)	+
Ammonia anhydrous 25%	+	Methanol (methyl alcohol) <85 %	-
Amyl acetate	+	Mineral oil	+
Amyl alcohol	+	Naphthalene	-
Hydrocarbons, aromatic (benzene, toluene, xylene)	+	Naphthene	-
Barium hydroxide	+	Sodium carbonate (soda)	+
Petrol (92-100 octane)	+	Sodium bicarbonate (sodium hydrogen carbonate)	+
Hydrobromic acid <10 %	+	Sodium chloride (table salt)	+
Butyl acetate	+	Sodium hydroxide >20 % (caustic soda)	0
Butyl alcohol	+	Caustic soda	+
Calcium hydroxide (slaked lime)	+	Heating oil, diesel	+
Chloroacetic acid	-	Oxalic acid <25 % (ethanedioic acid)	+
Chloroform (trichlormethane)	0	Perchloraethylene	0
Chlorosulphuric acid (wet and dry)	-	Kerosene	+
Chlorinated water (swimming pool concentration)	+	Oils, vegetable and animal	+
Hydrochloric acid	+	Phosphoric acid <5%	+
Chromium bath	+	Phthalic acid, phthalic anhydride	+
Chromic acid	+	Crude oil	+
Diesel fuels	+	Nitric acid <5%	0
Mineral oil and mineral oil products	+	Hydrochloric acid <10 %	+
Acetic acid diluted <5%	+	Sulphur dioxide (wet and dry)	+
Ethanol <85 % (ethyl alcohol)	+	Carbon disulphide	+
Greases, oils and waxes	+	Sulphuric acid <5%	0
Hydrofluoric acid diluted	0	White spirit	+
Tannic acid diluted <7%	+	Carbon tetrachloride (tetrachloromethane)	+
Glycerin (trihydroxipropane)	+	Tetralin (tetrahydronaphthalene)	0
Glycol	0	Toluene	-
Humic acid	+	Trichloraethylene	0
Impregnating oils	+	Hydrogen peroxide <30 % (hydrogen superoxide)	+
Potash	+	Xylene	-

^{+ =} resistant 0 = for a limited time - = not resistant *The storage of all WEICON Plastic Metal types was carried out at +20°C chemical temperature.

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